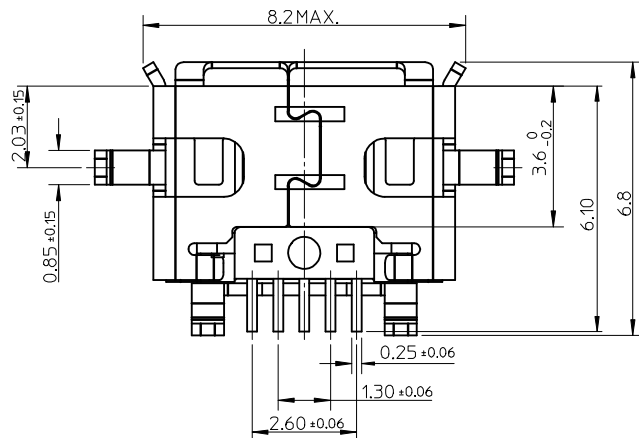
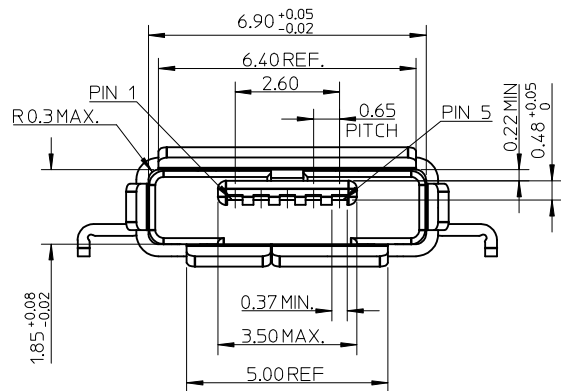
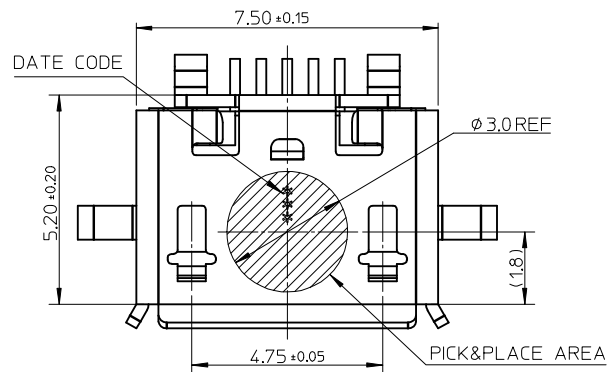
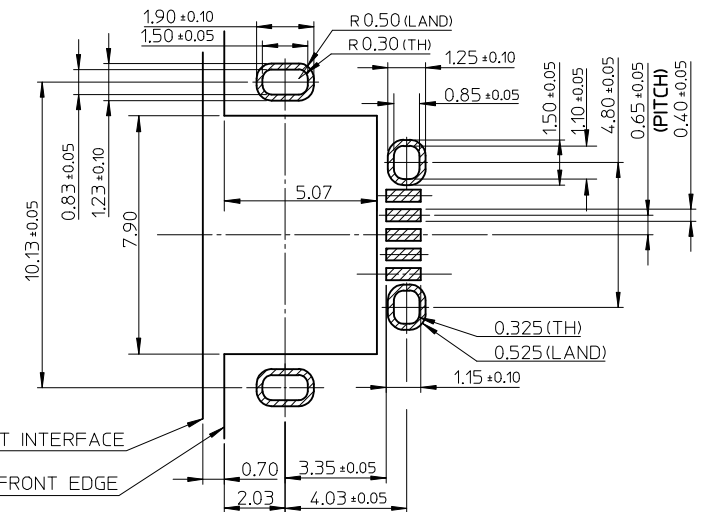
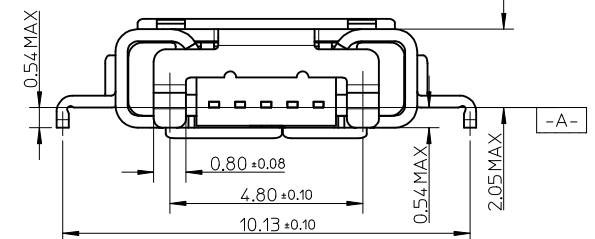


NOTES:

- MATERIAL:
HOUSING: LCP, BLACK, UL94V-0;
TERMINAL: COPPER ALLOY, THICKNESS: 0.15mm;
SHIELD CASE: STAINLESS STEEL, THICKNESS: 0.30mm.
- PLATING:
TERMINAL: CONTACT AREA: GOLD FLASH (0.11 MICRON MINIMUM) OVER MINIMUM 0.75 MICRON Pd/Ni;
SOLDER TAIL AREA: GOLD FLASH (0.05 MICRON MINIMUM);
UNDER PLATING: NICKEL 2.0 MICROMN MINIMUM.
SHIELD: MATTE TIN 1.27 MICRON MINIMUM.
UNDER PLATING: NICKEL 1.27 MICRON MINIMUM.
- TAIL COPLANARITY 0.08mm MAXIMUM.
- PRODUCT SPECIFICATION: PS-47589-001; PACKAGING SPECIFICATION: PK-47654-001.
- COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV DIRECTIVE 2000/53/EC.



RECOMMENDED PCB LAYOUT (Thickness=0.6mm~1.2mm)



REVISED	EC NO.	DRWN:X0ZHANG	CHKD:X0ZHANG	APPR:AYIN	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	TITLE	DOCUMENT NO.	SHEET NO.
							mm	INCH	MM ONLY	DATE						
1	SH2013-0426	2013/05/28	2013/05/28	2013/06/13		$\nabla_A=0$	4 PLACES	±---	±---	XJSONG	2008/03/26			MICRO USB AB REC. SINK TYPE ASS'Y	SD-47654-001	1 OF 1
2						$\nabla_C=0$	3 PLACES	±---	±---	CHECKED BY	DATE					
3						$\nabla_D=0$	2 PLACES	±0.15	±---	JTIAN	2008/03/26			molex	47654-0001	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION
4						$\nabla_E=0$	1 PLACE	±0.25	±---	APPROVED BY	DATE					
5							0 PLACE	±---	±---	HWWANG	2008/03/26			molex	47654-0001	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION
6							ANGULAR ± 3 °		MATERIAL NO.							
7							DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE							
8									A3							